# Intelligent Power Module (IPM), 600 V, 10 A

The STK544UC63K–E is a fully-integrated inverter power stage consisting of a high-voltage driver, six IGBT's and a thermistor, suitable for driving permanent magnet synchronous (PMSM) motors, brushless-DC (BLDC) motors and AC asynchronous motors. The IGBT's are configured in a 3-phase bridge with separate emitter connections for the lower legs for maximum flexibility in the choice of control algorithm. The power stage has a full range of protection functions including cross-conduction protection, external shutdown and under-voltage lockout functions. An internal comparator and reference connected to the over-current protection circuit allows the designer to set the over-current protection level.

#### Features

- Three-phase 10 A/600 V IGBT Module with Integrated Drivers
- Built-in Under Voltage Protection
- Cross-conduction Protection
- ITRIP Input to Shut Down All IGBTs
- Integrated Bootstrap Diodes and Resistors
- Thermistor for Substrate Temperature Measurement
- UL1557 Certification (File Number: E339285)
- These Devices are Pb-Free and are RoHS Compliant

## **Typical Applications**

- Industrial Drives
- Industrial Pumps
- Industrial Fans
- Industrial Automation

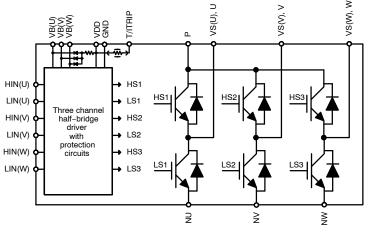


Figure 1. Functional Diagram



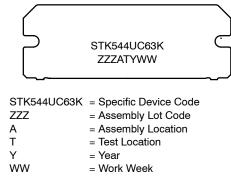
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SIP23 62x21.8 CASE 127FC

#### MARKING DIAGRAM



Device marking is on package top side

## ORDERING INFORMATION

Device	Package	Shipping (Qty/Packing)
STK544UC63K-E	SIP23 62x21.8FP-4 (Pb-Free)	80/Box

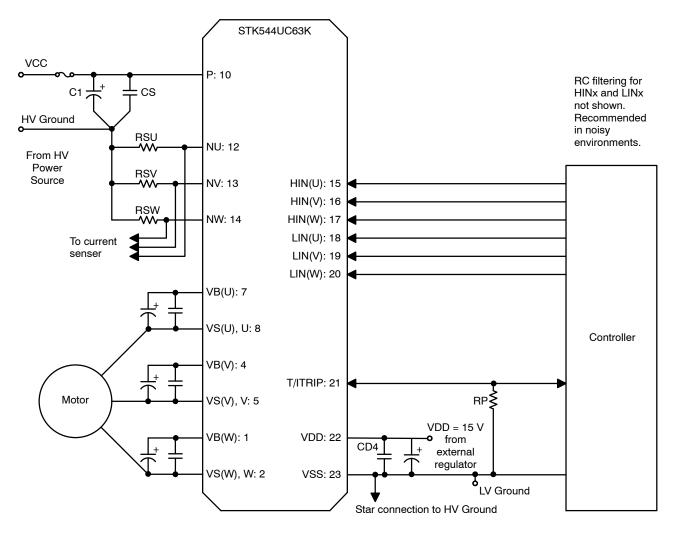


Figure 2. Application Schematic

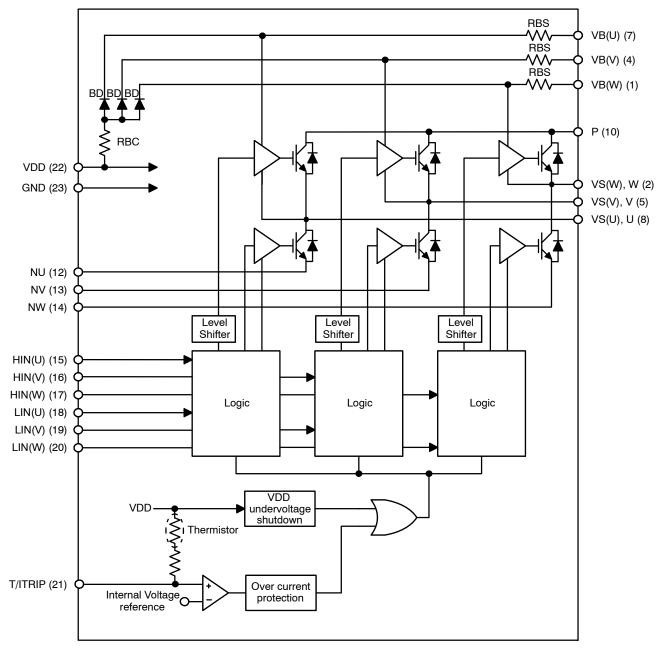


Figure 3. Simplified Block Diagram

#### **PIN DESCRIPTION**

Pin No.	Name	Description
1	VB(W)	High Side Floating Supply Voltage for W phase
2	VS(W), W	Internally connected to W phase high side driver ground. W phase output
4	VB(V)	High Side Floating Supply voltage for V phase
5	VS(V), V	Internally connected to V phase high side driver ground. V phase output
7	VB(U)	High Side Floating Supply voltage for U phase
8	VS(U), U	Internally connected to U phase high side driver ground. U phase output
10	Р	Positive Bus Input Voltage
12	NU	Low Side Emitter Connection – Phase U
13	NV	Low Side Emitter Connection – Phase V
14	NW	Low Side Emitter Connection – Phase W
15	HIN(U)	Logic Input High Side Gate Driver – Phase U
16	HIN(V)	Logic Input High Side Gate Driver – Phase V
17	HIN(W)	Logic Input High Side Gate Driver – Phase W
18	LIN(U)	Logic Input Low Side Gate Driver - Phase U
19	LIN(V)	Logic Input Low Side Gate Driver - Phase V
20	LIN(W)	Logic Input Low Side Gate Driver - Phase W
21	T/ITRIP	Temperature Monitor and Shut-down pin
22	VDD	+15 V Main Supply
23	VSS	Negative Main Supply

1. Pins 3, 6, 9 and 11 are not present

## ABSOLUTE MAXIMUM RATINGS (at Tc = 25°C) (Note 2)

Symbol	Rating	Conditions	Value	Unit
V <sub>CC</sub>	Supply voltage	P to NU, NV, NW, surge < 500 V (Note 3)	450	V
$V_{CE}$	Collector-emitter voltage	P to U, V, W; U to NU; V to NV; W to NW	600	V
lo	Output current	P, U, V, W, NU, NV, NW terminal current	±10	А
		P, U, V, W, NU, NV, NW terminal current, Tc = 100°C	±5	А
lop	Output peak current	P, U, V, W, NU, NV, NW terminal current, pulse width 1 ms	±20	А
Pd	Maximum power dissipation	IGBT per 1 channel	20	W
$V_{BS}$	Gate driver supply voltage	VB(U) to VS(U), VB(V) to VS(V), VB(W) to VS(W), VDD to VSS (Note 4)	-0.3 to +20.0	V
VIN	Input signal voltage	HIN(U), HIN(V), HIN(W), LIN(U), LIN(V), LIN(W)	-0.3 to +7.0	V
VITRIP	ITRIP terminal voltage	T/ITRIP terminal	VSS to +5.0	V
Tj	Junction temperature	IGBT, FRD	150	°C
Tstg	Storage temperature		-40 to +125	°C
Тс	Operating case temperature	IPM case temperature	-40 to +100	°C
MT	Tightening torque	Case mounting screws	0.9	Nm
Vis	Isolation voltage	50 Hz sine wave AC 1 minute (Note 5)	2000	Vrms

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected. 2. Refer to ELECTRICAL CHARACTERISTICS, RECOMMENDED OPERATING RANGES and/or APPLICATION INFORMATION for Safe

Operating parameters. 3. This surge voltage developed by the switching operation due to the wiring inductance between P and NU, NV, NW terminal.

VBS = VB(U) to VS(U), VB(V) to VS(V), VB(W) to VS(W).
Test conditions: AC2500V, 1 s.

#### **RECOMMENDED OPERATING CONDITIONS**

Symbol	bol Rating Conditions		Min	Тур	Max	Unit
V <sub>CC</sub>	Supply voltage	P to NU, NV, NW	0	280	450	V
VBS	Gate driver supply voltage	VB(U) to VS(U), VB(V) to VS(V), VB(W) to VS(W)	13.0	15	17.5	V
V <sub>DD</sub>		VDD to VSS	14.0	15	16.5	V
VIN(ON)	ON-state input voltage	HIN(U), HIN(V), HIN(W), LIN(U),	0	-	0.3	V
VIN(OFF)	OFF-state input voltage	LIN(V), LIN(W)	3.0	-	5.0	V
f <sub>PWM</sub>	PWM frequency		1	-	20	kHz
DT	Dead time	Turn-off to Turn-on (external)	0.5	-	-	μs
PWIN	Allowable input pulse width	ON and OFF	1	-	-	μs
	Tightening torque	'M3' type screw	0.6	-	0.9	Nm

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

#### **ELECTRICAL CHARACTERISTICS** (Tc = $25^{\circ}$ C, V<sub>BIAS</sub> (V<sub>BS</sub>, V<sub>DD</sub>) = 15 V unless otherwise noted) T -----Der

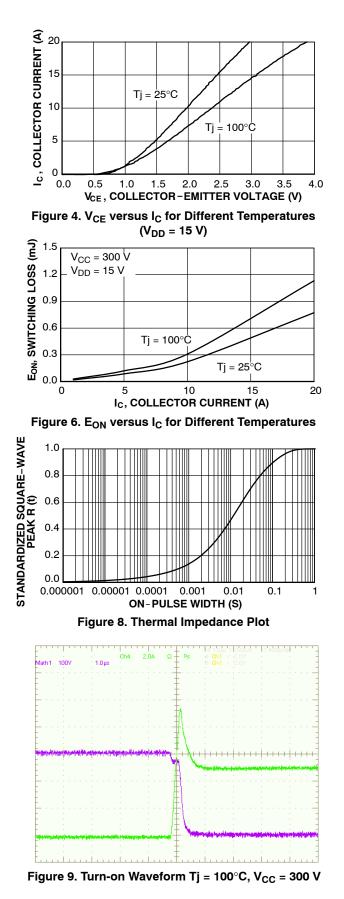
Symbol	Parameter	Test Condition	Min	Тур	Max	Unit
OWER O	UTPUT SECTION					
I <sub>CE</sub>	Collector-emitter leakage current	V <sub>CE</sub> = 600 V	-	-	0.1	mA
IR(BD)	Bootstrap diode reverse current	p diode reverse current VR(DB) = 600 V		-	0.1	mA
V <sub>CE</sub> (SAT) Collector to emitter saturation voltage		IC = 10 A, Tj = 25°C	-	2.1	2.7	V
		IC = 5 A, Tj = 100°C	-	1.7	-	V
VF	Diode forward voltage	IF = 10 A, Tj = 25°C	-	2.2	2.8	V
		IF = 5 A, Tj = 100°C	-	1.7	-	V
VF(BD)	Bootstrap diode forward voltage	IF = 0.1 A		2.0	-	V
R <sub>BC</sub>	Bootstrap circuit resistance	Resistor value for common boot charge line	-	2	-	Ω
R <sub>BS</sub>		Resistor value for separate boot charge line	-	10	-	Ω
θj–c(T)	Junction to case thermal resistance	IGBT	-	4.9	6.2	°C/W
θ-c(D)		FRD	I	8.5	10.6	°C/W
RIVER SI	ECTION					
ID	Gate driver consumption current	V <sub>BS</sub> = 15 V (Note 6), per driver	-	0.08	0.4	mA
ID		V <sub>DD</sub> = 15 V, total	-	2.0	4.0	mA
VIN H	High level Input voltage	HIN(U), HIN(V), HIN(W), LIN(U), LIN(V), LIN(W) to VSS		-	-	V
VIN L	Low level Input voltage			-	0.8	V
I <sub>IN+</sub>	Logic 0 input leakage current		76	118	160	μA
I <sub>IN-</sub>	Logic 1 input leakage current		97	150	203	μA
V <sub>ITRIP</sub>	ITRIP threshold voltage	T/ITRIP to VSS	3.67	4.17	4.67	V
t <sub>ITRIP</sub>	ITRIP to shutdown propagation delay		0.8	1.1	1.4	μs
t <sub>ITRIPBL</sub>	ITRIP blanking time		-	0.9	-	μs
FLTCLR	FAULT clearance delay time	Automatic reset after protection	6	9	12	ms
DT	Dead time (Internal dead time injected by driver)		220	300	380	μs
V <sub>CCUV+</sub> V <sub>BSUV+</sub>	$V_{\mbox{\scriptsize DD}}$ and $V_{\mbox{\scriptsize BS}}$ supply undervoltage positive going input threshold		10.5	11.1	11.7	V
V <sub>CCUV-</sub> V <sub>BSUV-</sub>	V <sub>DD</sub> and V <sub>BS</sub> supply undervoltage negative going input threshold		10.3	10.9	11.5	V

#### ELECTRICAL CHARACTERISTICS (Tc = 25°C, V<sub>BIAS</sub> (V<sub>BS</sub>, V<sub>DD</sub>) = 15 V unless otherwise noted)

Symbol	Parameter	Test Condition	Min	Тур	Max	Unit
V <sub>CCUVH</sub> V <sub>BSUVH</sub>	$V_{DD}$ and $V_{BS}$ supply undervoltage lockout hysteresis		0.14	0.2	-	V
WITCHIN	IG CHARACTER		•			
t <sub>ON</sub>	Switching time	IC = 10 A, Tj = 25°C	-	0.35	0.7	μs
t <sub>OFF</sub>			-	0.45	0.8	μs
E <sub>ON</sub>	Turn-on switching loss	IC = 5 A, Tj = 25°C	-	89	-	μJ
E <sub>OFF</sub>	Turn-off switching loss		-	74	-	μJ
E <sub>TOT</sub>	Total switching loss		-	163	-	μJ
E <sub>ON</sub>	Turn-on switching loss	IC = 5 A, Tj = 100°C	-	125	-	μJ
E <sub>OFF</sub>	Turn-off switching loss		-	82	-	μJ
E <sub>TOT</sub>	Total switching loss		-	207	-	μJ
E <sub>REC</sub>	Diode reverse recovery energy	IC = 5 A, Tj = 100°C	-	40	-	μJ
t <sub>RR</sub>	Diode reverse recovery time		-	150	-	ns
RBSOA	Reverse bias safe operating area	IC = 20 A, V <sub>CE</sub> = 450 V	F	Full Square		
SCSOA	Short circuit safe operating area	V <sub>CE</sub> = 400 V, Tj = 150°C	5	-	-	μs

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 6. VBS = VBU to U, VBV to V, VBW to W

### **TYPICAL CHARACTERISTICS INV SECTION**



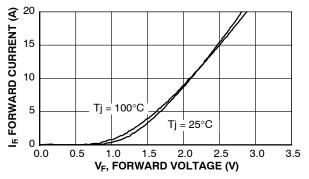


Figure 5. V<sub>F</sub> versus I<sub>F</sub> for Different Temperatures

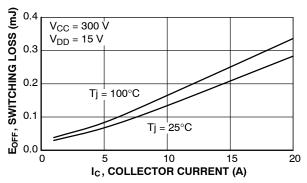


Figure 7. E<sub>OFF</sub> versus I<sub>C</sub> for Different Temperatures

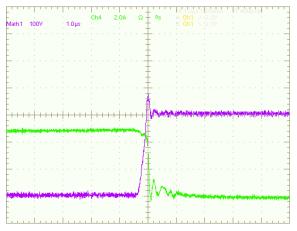
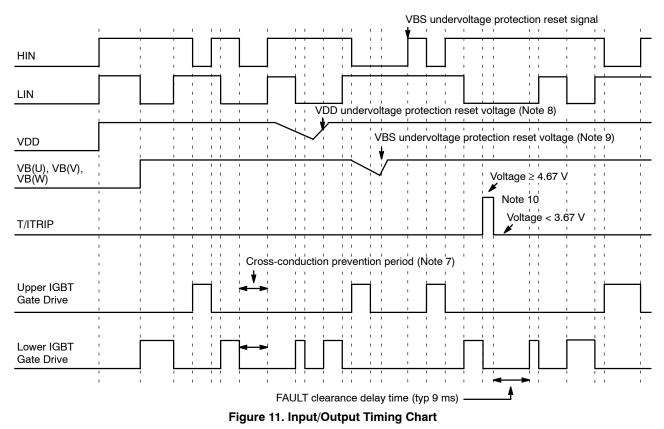


Figure 10. Turn-off Waveform Tj = 100°C, V<sub>CC</sub> = 300 V

### **APPLICATIONS INFORMATION**

#### Input/Output Timing Chart



NOTES:

7. This section of the timing diagram shows the effect of cross-conduction prevention.

8. This section of the timing diagram shows that when the voltage on V<sub>DD</sub> decreases sufficiently all gate output signals will go low, switching off all six IGBTs. When the voltage on V<sub>DD</sub> rises sufficiently, normal operation will resume.

This section shows that when the bootstrap voltage on VB(U) (VB(V), VB(W)) drops, the corresponding high side output U (V, W) is 9. switched off. When the voltage on VB(U) (VB(V), VB(W)) rises sufficiently, normal operation will resume. 10. This section shows that when the voltage on ITRIP exceeds the threshold, all IGBT's are turned off. Normal operation resumes later after

the over-current condition is removed.

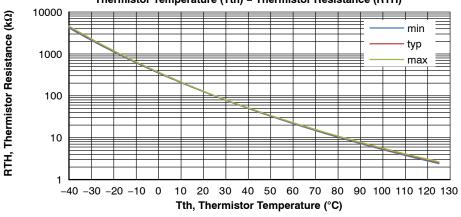
#### Input/Output Logic Table

#### Table 1. INPUT/OUTPUT LOGIC TABLE

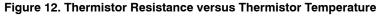
	INPUT			OUTPUT			
HIN	LIN	T/ITRIP	High Side IGBT	Low Side IGBT	U, V, W		
L	Н	L	ON	OFF	Р		
Н	L	L	OFF	ON	NU, NV, NW		
Н	Н	L	OFF	OFF	High Impedance		
L	L	L	OFF	OFF	High Impedance		
Х	Х	Н	OFF	OFF	High Impedance		

#### **Thermistor Characteristics**

Symbol	Parameter	Condition	Min	Тур	Max	Unit
R <sub>25</sub>	Resistance	Tth = 25°C	99	100	101	kΩ
R <sub>125</sub>		Tth = 125°C	2.40	2.52	2.65	kΩ
В	B-Constant (25 to 50°C)		-4207	4250	4293	к
	Temperature Range		-40	-	+125	°C



Thermistor Temperature (Tth) – Thermistor Resistance (RTH)



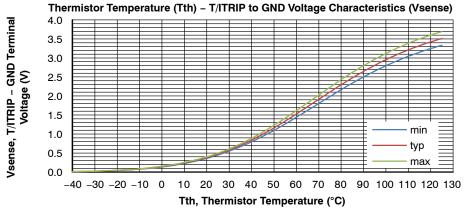
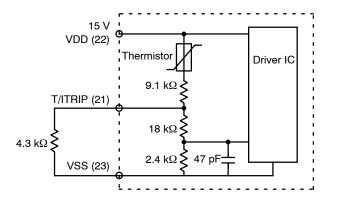


Figure 13. Thermistor Voltage versus Thermistor Temperature Conditions: RP = 4.3 k $\Omega$  1% Pull-down and VDD = 15.0 V (See below)





## **TEST CIRCUITS**

• I<sub>CE, IR(DB)</sub>

	U+	V+	W+	U-	<b>V</b> -	W–
А	10	10	10	8	5	2
В	8	5	2	12	13	14

U+,V+,W+: High side phase

U-,V-,W-: Low side phase

• V<sub>CE</sub>(sat) (Test by pulse) U+

10

8

15

А

В

С

V+

10

5

16

	U(DB)	V(DB)	W(DB)
A	7	4	1
В	23	23	23

W+

10

2

17

U–

8

12

18

V-

5

13

19

W-

2

14

20

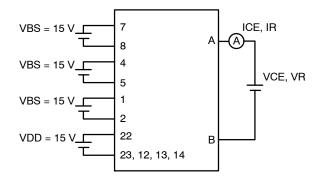


Figure 15. Test Circuit for  $I_{CE}$ 

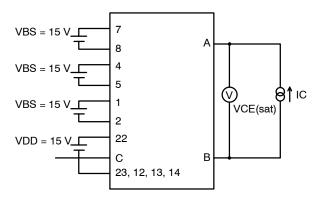


Figure 16. Test Circuit for V<sub>CE(SAT)</sub>

• VF (Test by pulse)

	U+	V+	W+	U-	<b>V</b> -	W–
А	10	10	10	8	5	2
В	8	5	2	12	13	14

	U(DB)	V(DB)	W(DB)	
А	7	4	1	
В	22	22	22	

• ID

	VBS U+	VBS V+	VBS W+	V <sub>DD</sub>	
А	7	4	1	22	
В	8	5	2	23	

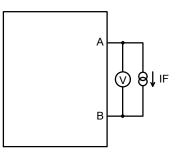


Figure 17. Test Circuit for V<sub>F</sub>

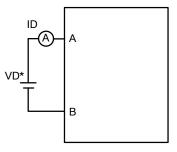
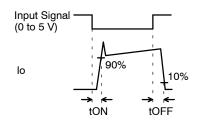


Figure 18. Test Circuit for ID

• Switching time (The circuit is a representative example of the lower side U phase.)

	U+	V+	W+	U-	V-	W-
А	10	10	10	10	10	10
В	12	13	14	12	13	14
С	8	5	2	10	10	10
D	12	13	14	8	5	2
E	15	16	17	18	19	20



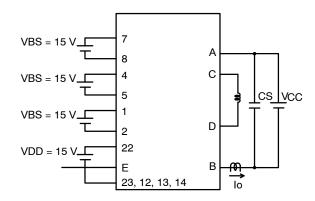
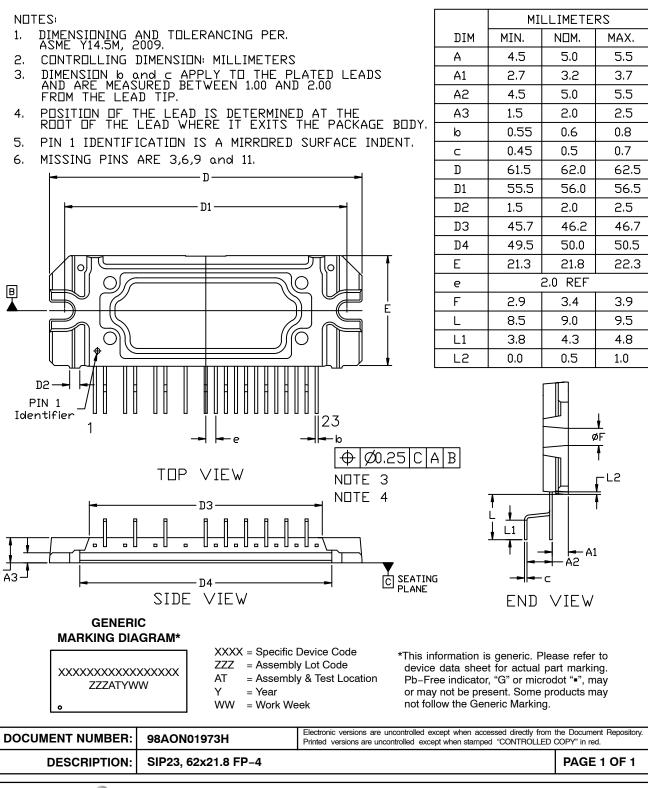


Figure 19. Test Circuit for Switching Time



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